

樣品承認書

SAMPLE APPROVAL SHEET

CUSTOMER:

SIZE UP :

声表面谐振器

Volume:

R315M

F11-DIP

NUMBER:

DATE:

承認後請寄回一份

PLS SEND BACK ONE COPY TO US AFTER YOUR APPROVAL

承認結果	客戶簽名	客戶承認章	日期	備注
CONCLUSION	SIGNATURE	STAMP	DATE	REMARK
合格				
ACCEPT				
不合格				
REJECT				

制表: JACK LIU/

审核:

(公章)

尊敬的客户:请您抽出一点时间,在7-10个工作日内将承认书回签,若未回签,以视默认.谢谢合作!

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1. Package Dimension

(F-11)

Unit: mm



Pin No.	Function
Pin No.	Functio

- 1. Input
- 2. Ground
- 3. Ground
- 4. Output

2. Marking

KON 315.00

- 1. Color: Black or Blue
- 2. DR: Manufacture's logo
- 3. 1: One-port SAW Resonator
- 4. 315.00: Center Frequency (MHz)
- 3. Equivalent LC Model



4. Performance

4.1 Maximum Rating

DC Voltage V _{DC}	10V		
AC Voltage V _{PP}	10V (50Hz/60Hz)		
Operation Temperature	-40 to +85		
Storage Temperature	-45 to +85		
RF Power Dissipation	0dBm		

4.2 Electronic Characteristics

Item		Units	Minimum	Typical	Maximum
Center Frequency fo		MHz	314.925	315	315.075
Insertion Loss		dB	—	1.3	2.5
Quality Factor	Unloaded Q	—	—	12,000	
	50 Loaded Q	—		1,900	
Temperature	Turnover Temperature		10	25	40
Stability	Turnover Frequency	KHz		fo	
	Freq.Temp.Coefficient	ppm/ ²	—	0.037	
Frequency Aging		ppm/yr		<±10	
DC Insulation Resistance		М	1.0	_	
RF Equivalent RLC Model	Motional Resistance R ₁		—	23	29
	Motional Inductance L ₁	μH		115.2	
	Motional Capacitance C ₁	fF	—	2.2	—
	Shunt Static Capacitance Co	pF	2.1	2.4	2.7

4.3 Frequency Characteristics



4.4 Test Circuit



Note: Reference temperature shall be 25 ± 2 . However, the measurement may be carried out at 5 to 35 unless there is a dispute.

5. Reliability

5.1 Mechanical Shock: The components shall remain within the electrical specifications after 1000 shocks, acceleration 392 m/s^2 , duration 6 milliseconds.

5.2 Vibration Fatigue: The components shall remain within the electrical specifications after loaded vibration at 20 Hz, amplitude 1.5 mm, for 2 hours.

5.3 Terminal Strength: The components shall remain within the electrical specifications after pulled 2 kgs weight for 10 seconds towards an axis of each terminal.

5.4 High Temperature Storage: The components shall remain within the electrical specifications after being kept at the 85 ± 2 for 48 hours, then kept at room temperature for 2 hours.

5.5 Low Temperature Storage: The components shall remain within the electrical specifications after being kept at the -25 ± 2 for 48 hours, then kept at room temperature for 2 hours.

5.6 Temperature Cycle: The components shall remain within the electrical specifications after 5 cycles of high and low temperature testing (one cycle: 80 for 30 minutes
25 for 5 minutes -25 for 30 minutes)than kept at room temperature for 2 hours.

5.7 Solder-heat Resistance: The components shall remain within the electrical specifications after dipped in the solder at 260 for 10 ± 1 seconds, then kept at room temperature for 2 hours. (Terminal must be dipped leaving 1.5 mm from the case).

5.8 Solderability: Solderability of terminal shall be kept at more than 80% after dipped in the solder flux at 230 ± 5 for 5 ± 1 seconds.

6. Remarks

6.1 Static voltage

Static voltage between signal load & ground may cause deterioration & destruction of the component. Please avoid static voltage.

6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning.

6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.